onsemi

Single Inverter with Schmitt-Trigger Input

MC74HC1G14

The MC74HC1G14 is a high speed CMOS inverter with Schmitt-Trigger input fabricated with silicon gate CMOS technology.

The internal circuit is composed of multiple stages, including a buffer output which provides high noise immunity and stable output.

The MC74HC1G14 output drive current is 1/2 compared to MC74HC series.

Features

- High Speed: $t_{PD} = 7 \text{ ns} (Typ)$ at $V_{CC} = 5 \text{ V}$
- Low Power Dissipation: $I_{CC} = 1 \mu A$ (Max) at $T_A = 25^{\circ}C$
- High Noise Immunity
- Balanced Propagation Delays (t_{pLH} = t_{pHL})
- Symmetrical Output Impedance $(I_{OH} = I_{OL} = 2 \text{ mA})$
- Chip Complexity: < 100 FETs
- -Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

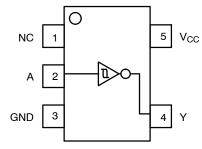


Figure 1. Pinout

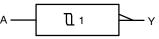
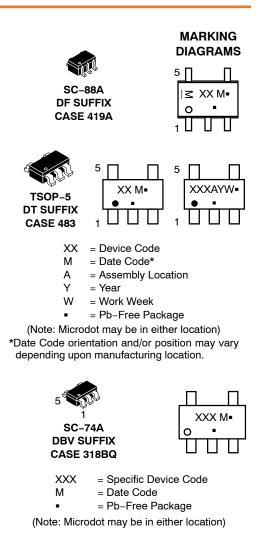


Figure 2. Logic Symbol

PIN ASSIGNMENT					
1	N/C				
2	А				
3	GND				
4	Y				
5	V _{CC}				



FUNCTION TABLE

Input	Output
Α	Y
L	Н
Н	L

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

MC74HC1G14

MAXIMUM RATINGS

Symbol	Parameter		Value	Unit
V _{CC}	DC Supply Voltage		–0.5 to +6.5	V
V _{IN}	DC Input Voltage		–0.5 to V _{CC} +0.5	V
V _{OUT}	DC Output Voltage		–0.5 to V _{CC} +0.5	V
I _{IK}	DC Input Diode Current		±20	mA
Ι _{ΟΚ}	DC Output Diode Current		±20	mA
I _{OUT}	DC Output Source/Sink Current		±12.5	mA
I _{CC} or I _{GND}	DC Supply Current per Supply Pin or Ground Pin	±25	mA	
T _{STG}	Storage Temperature Range		–65 to +150	°C
TL	Lead Temperature, 1 mm from Case for 10 Seconds		260	°C
ТJ	Junction Temperature Under Bias		+150	°C
θ_{JA}	Thermal Resistance (Note 1)	SC-88A SC-74A	377 320	°C/W
PD	Power Dissipation in Still Air	SC-88A SC-74A	332 390	mW
MSL	Moisture Sensitivity		Level 1	
F _R	Flammability Rating	Oxygen Index: 28 to 34	UL 94 V-0 @ 0.125 in	
V _{ESD}	ESD Withstand Voltage (Note 2)	Human Body Model Charged Device Model	2000 1000	V
I _{LATCHUP}	Latchup Performance (Note 3)		±100	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality Measured with minimum pad spacing on an FR4 board, using 10 mm-by-1 inch, 20 ounce copper trace with no air flow per JESD51-7.
 HBM tested to ANSI/ESDA/JEDEC JS-001-2017. CDM tested to JESD22-C101-F. JEDEC recommends that ESD qualification to

EIA/JESD22-A115A (Machine Model) be discontinued per JEDEC/JEP172A.

3. Tested to EIA/JESD78 Class II.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit
V _{CC}	DC Supply Voltage	2.0	6.0	V
V _{IN}	DC Input Voltage	0.0	V _{CC}	V
V _{OUT}	DC Output Voltage	0.0	V _{CC}	V
T _A	Operating Temperature Range	-55	+125	°C
t _r , t _f	Input Rise and Fall Time $\begin{array}{c} V_{CC} = 2.0 \ V \\ V_{CC} = 2.3 \ V \ to \ 2.7 \ V \\ V_{CC} = 3.0 \ V \ to \ 3.6 \ V \\ V_{CC} = 4.5 \ V \ to \ 6.0 \ V \end{array}$		No Limit No Limit No Limit No Limit	ns/V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

DC ELECTRICAL CHARACTERISTICS

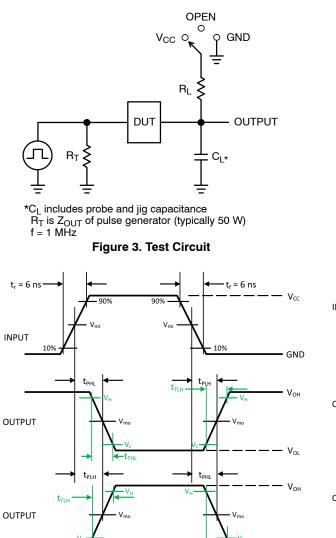
		Test	Vcc	Т	A = 25°	C	-40°C ≤ 1	Γ _A ≤ 85°C	–55°C ≤ T	<mark>A</mark> ≤ 125°C	
Symbol	Parameter	Conditions	(V)	Min	Тур	Max	Min	Max	Min	Max	Unit
V _{T+}	Positive Threshold		3.0	-	2.0	2.2	-	2.2	-	2.2	V
	Voltage		4.5	-	3.0	3.15	-	3.15	-	3.15	
			5.5	-	3.6	3.85	-	3.85	-	3.85	
V_{T-}	Negative Threshold		3.0	0.9	1.5	-	0.9	-	0.9	-	V
	Voltage		4.5	1.35	2.3	-	1.35	-	1.35	-	
			5.5	1.65	2.9	-	1.65	-	1.65	-	
V _H	Hysteresis Voltage		3.0 4.5 5.5	0.30 0.40 0.50	0.57 0.67 0.74	1.20 1.40 1.60	0.30 0.40 0.50	1.20 1.40 1.60	0.30 0.40 0.50	1.20 1.40 1.60	V
V _{OH}	High-Level Output Voltage	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $I_{OH} = -20 \ \mu A$	2.0 3.0 4.5 6.0	1.9 2.9 4.4 5.9	2.0 3.0 4.5 6.0		1.9 2.9 4.4 5.9		1.9 2.9 4.4 5.9		V
			4.5 6.0	4.18 5.68	4.31 5.80		4.13 5.63		4.08 5.58	-	
V _{OL}	Low-Level Output Voltage		2.0 3.0 4.5 6.0	- - -	0.0 0.0 0.0 0.0	0.1 0.1 0.1 0.1	- - -	0.1 0.1 0.1 0.1		0.1 0.1 0.1 0.1	V
		$\begin{array}{l} V_{IN} = V_{IH} \text{ or } V_{IL} \\ I_{OL} = 2 \text{ mA} \\ I_{OL} = 2.6 \text{ mA} \end{array}$	4.5 6.0		0.17 0.18	0.26 0.26	- -	0.33 0.33	- -	0.40 0.40	
I _{IN}	Input Leakage Current	V _{IN} = 6.0 V or GND	6.0	_	-	±0.1	_	±1.0	_	±1.0	μΑ
I _{CC}	Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND	6.0	-	-	1.0	-	10	_	40	μA

AC ELECTRICAL CHARACTERISTICS

			Т	T _A = 25°C		$-40^\circ C \leq T_A \leq 85^\circ C$		$-55^\circ C \leq T_A \leq 125^\circ C$		
Symbol	Parameter	Test Conditions	Min	Тур	Max	Min	Max	Min	Max	Unit
t _{PLH} ,	Propagation Delay,	$V_{CC} = 5.0 \text{ V} \text{ C}_{L} = 15 \text{ pF}$	-	3.5	15	-	20	_	25	ns
tphl	Input Å or B to Y	$ \begin{array}{l} V_{CC} = 2.0 \ V \ C_L = 50 \ pF \\ V_{CC} = 3.0 \ V \\ V_{CC} = 4.5 \ V \\ V_{CC} = 6.0 \ V \end{array} $		19 10.5 7.5 6.5	100 27 20 17		125 35 25 21		155 90 35 26	
t _{TLH} ,	Output Transition	$V_{CC} = 5.0 \text{ V}$ C _L = 15 pF	-	3	10	-	15	-	20	ns
t _{THL}	Time	$ \begin{array}{l} V_{CC} = 2.0 \ V \ C_L = 50 \ pF \\ V_{CC} = 3.0 \ V \\ V_{CC} = 4.5 \ V \\ V_{CC} = 6.0 \ V \end{array} $		25 16 11 9	125 35 25 21		155 45 31 26		200 60 38 32	
C _{IN}	Input Capacitance		-	5	10	-	10	-	10	pF
				Typical @ 25°C, V _{CC} = 5.0 V						

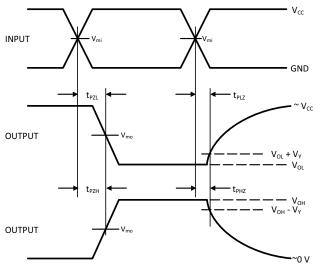
 C_{PD} Power Dissipation Capacitance (Note 4)10pF4. C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.
Average operating current can be obtained by the equation: $I_{CC(OPR)} = C_{PD} \bullet V_{CC} \bullet f_{in} + I_{CC}$. C_{PD} is used to determine the no-load dynamic power consumption; $P_D = C_{PD} \bullet V_{CC}^2 \bullet f_{in} + I_{CC} \bullet V_{CC}$.

MC74HC1G14



Test	Switch Position	C _L , pF	R_L, Ω
t_{PLH} / t_{PHL}	Open		Х
t _{TLH} / t _{THL} (Note 5)	Open	See AC Characteristics Table	х
t _{PLZ} / t _{PZL}	V _{CC}	Table	1 k
t_{PHZ} / t_{PZH}	GND		1 k

X – Don't Care





Vol

		V _{mo} , V				
v_{cc}, v	V _{mi} , V	t _{PLH} , t _{PHL}	$t_{\text{PZL}}, t_{\text{PLZ}}, t_{\text{PZH}}, t_{\text{PHZ}}$	V _L , V	V _H , V	V _Y , V
3.0 to 3.6	V _{CC} /2	V _{CC} /2	V _{CC} /2	V _{OL} + 0.1 (V _{OH} – V _{OL})	V _{OL} + 0.9 (V _{OH} – V _{OL})	0.3
4.5 to 5.5	V _{CC} /2	V _{CC} /2	V _{CC} /2	V _{OL} + 0.1 (V _{OH} – V _{OL})	V _{OL} + 0.9 (V _{OH} – V _{OL})	0.3

5. t_{TLH} and t_{THL} are measured from 10% to 90% of (V_{OH} – V_{OL}), and 90% to 10% of (V_{OH} – V_{OL}), respectively.

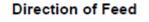
ORDERING INFORMATION

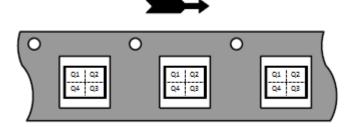
Device	Packages	Specific Device Code	Pin 1 Orientation (See below)	Shipping [†]
MC74HC1G14DFT1G	SC-88A	HA	Q2	3000 / Tape & Reel
MC74HC1G14DFT1G-Q* (Please contact onsemi)	SC-88A	HA	Q2	3000 / Tape & Reel
MC74HC1G14DFT2G	SC-88A	HA	Q4	3000 / Tape & Reel
MC74HC1G14DFT2G-Q* (Please contact onsemi)	SC-88A	HA	Q4	3000 / Tape & Reel
MC74HC1G14DTT1G-Q* (Please contact onsemi)	TSOP-5	HA	Q4	3000 / Tape & Reel
MC74HC1G14DBVT1G	SC-74A	HA	Q4	3000 / Tape & Reel
MC74HC1G14DBVT1G-Q* (Please contact onsemi)	SC-74A	HA	Q4	3000 / Tape & Reel

†For complete information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*-Q Suffix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

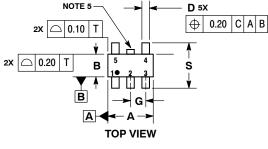
Pin 1 Orientation in Tape and Reel





PACKAGE DIMENSIONS

TSOP-5 **CASE 483 ISSUE N**



SIDE VIEW

0.05

С





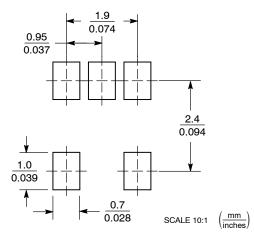
END VIEW

NOTES: 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. 2. CONTROLLING DIMENSION: MILLIMETERS.

- CONTROLLING DIMENSION: MILLIMETERS.
 MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
 DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.15 PER SIDE. DIMENSION A.
 OPTIONAL CONSTRUCTION: AN ADDITIONAL TRIMMED LEAD IS ALLOWED IN THIS LOCATION. TRIMMED LEAD NOT TO EXTEND MORE THAN 0.2 FROM BODY.

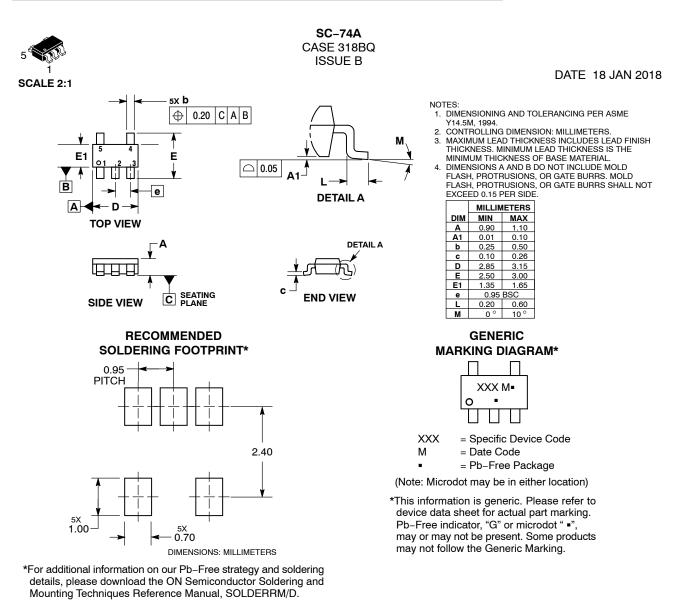
	MILLIMETERS				
DIM	MIN	MAX			
Α	2.85	3.15			
В	1.35	1.65			
С	0.90	1.10			
D	0.25	0.50			
G	0.95	BSC			
Н	0.01	0.10			
J	0.10	0.26			
К	0.20	0.60			
М	0 °	10 °			
S	2.50	3.00			

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.





DOCUMENT NUMBER:	98AON66279G	Electronic versions are uncontrolled except when accessed directly from Printed versions are uncontrolled except when stamped "CONTROLLED (
DESCRIPTION:	SC-74A		PAGE 1 OF 1
ON Semiconductor reserves the right the suitability of its products for any pa	to make changes without further notice to an articular purpose, nor does ON Semiconductor	stries, LLC dba ON Semiconductor or its subsidiaries in the United States y products herein. ON Semiconductor makes no warranty, representation r assume any liability arising out of the application or use of any product o icidental damages. ON Semiconductor does not convey any license under	or guarantee regarding r circuit, and specifically

0

onsemi

DATE 11 APR 2023

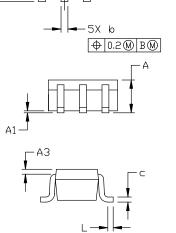


SCALE 2:1

SC-88A (SC-70-5/SOT-353) CASE 419A-02 ISSUE M

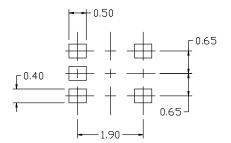
NDTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. 419A-01 DBSDLETE. NEW STANDARD 419A-02
- 4. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.1016MM PER SIDE.



e

F1



RECOMMENDED MOUNTING FOOTPRINT

For additional information on our
 Pb-Free strategy and soldering details,
 please download the DN Semiconductor
 Soldering and Mounting Techniques
 Reference Manual, SDLDERRM/D.

DIM	MILLIMETERS				
ויונע	MIN.	NDM.	MAX,		
А	0.80	0.95	1.10		
A1			0.10		
A3		0.20 REF			
b	0.10	0.20	0.30		
C	0.10		0,25		
D	1.80	2.00	5.20		
E	2.00	2.10	5.20		
E1	1.15	1.25	1.35		
e	0.65 BSC				
L	0.10	0.15	0.30		

GENERIC MARKING





*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

PIN 1. BASE PIN 1. ANODE PIN 1. ANODE 1 PIN 1. SOURCE 1 PIN 1. CATHODE 2. EMITTER 2. EMITTER 2. N/C 2. DRAIN 1/2 2. COMMON ANODE 3. BASE 3. BASE 3. ANODE 2 3. SOURCE 1 3. CATHODE 2 4. COLLECTOR 4. COLLECTOR 4. CATHODE 2 4. GATE 1 4. CATHODE 3 5. COLLECTOR 5. CATHODE 5. CATHODE 1 5. GATE 2 5. CATHODE 4 STYLE 6: STYLE 7: STYLE 8: STYLE 9: Note: Please refer to datasheet for style callout. If style type is not callout. If style type is not callout. If style type is not callout. Collector 3. EMITTER 1 3. BASE 3. N/C 3. ANODE 2 0. attinut the datasheet refer to the callout. If style type is not callout. If style type is not callout. Collector 4. COLLECTOR 2/BASE 1 5. COLLECTOR 4. BASE 4. ANODE out in the datasheet refer to the callout. If style type is not callout. Collector 5. COLLECTOR 2/BASE 1 5. COLLECTOR 5. EMITTER 5. ANODE out in the datasheet refer to the callout. If style type is not callout. Collector 6. COLLECTOR 2/BASE 1 5. COLLECTOR 5. EMITTER 5. ANODE datasheet pinout or pin assignment DOCUMENT NUMBER: 98ASB42984B	DESCRIPTION: SC-88A (SC-70-5/SOT-353)					PAGE 1 OF 1
2. EMITTER 2. EMITTER 2. N/C 2. DRAIN 1/2 2. COMMON ANODE 3. BASE 3. BASE 3. ANODE 2 3. SOURCE 1 3. CATHODE 2 4. COLLECTOR 4. COLLECTOR 4. CATHODE 2 4. GATE 1 4. CATHODE 3 5. COLLECTOR 5. CATHODE 5. CATHODE 1 5. GATE 2 5. CATHODE 4 STYLE 6: STYLE 7: STYLE 8: STYLE 9: Note: Please refer to datasheet for PIN 1. EMITTER 2 2. BASE 2 2. EMITTER 2. COLLECTOR 2. CATHODE 3. EMITTER 1 3. BASE 3. N/C 3. ANODE out in the datasheet refer to the cout in the datas	DOCUMENT NUMBER:					
2. EMITTER 2. EMITTER 2. N/C 2. DRAIN 1/2 2. COMMON ANODE 3. BASE 3. BASE 3. ANODE 2 3. SOURCE 1 3. CATHODE 2 4. COLLECTOR 4. COLLECTOR 4. CATHODE 2 4. GATE 1 4. CATHODE 3	PIN 1. EMITTER 2 2. BASE 2 3. EMITTER 1 4. COLLECTOR	PIN 1. BASE 2. EMITTER 3. BASE 4. COLLECTOR	PIN 1. CATHODE 2. COLLECTOR 3. N/C 4. BASE	PIN 1. ANODE 2. CATHODE 3. ANODE 4. ANODE	style callout. If style t out in the datasheet i	ype is not called refer to the device
STYLE 1: STYLE 2: STYLE 3: STYLE 4: STYLE 5:	PIN 1. BASE 2. EMITTER 3. BASE 4. COLLECTOR	PIN 1. ANODE 2. EMITTER 3. BASE 4. COLLECTOR	PIN 1. ANODE 1 2. N/C 3. ANODE 2 4. CATHODE 2	PIN 1. SOURCE 1 2. DRAIN 1/2 3. SOURCE 1 4. GATE 1	PIN 1. CATHODE 2. COMMON ANOE 3. CATHODE 2 4. CATHODE 3	DE

onsemi and ONSEMI are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights of others.

XXX = Specific Device Code

M = Date Code = Pb-Free Package

⁽Note: Microdot may be in either location)

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at www.onsemi.com/support/sales